

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	100	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current (Per Leg)	I_O	5	A
(Total)		10	
Non-Repetitive Peak Forward Surge Current 8.3ms	I_{FSM}	85	A
Single Half Sine-Wave Superimposed on Rated Load (Per Leg)			

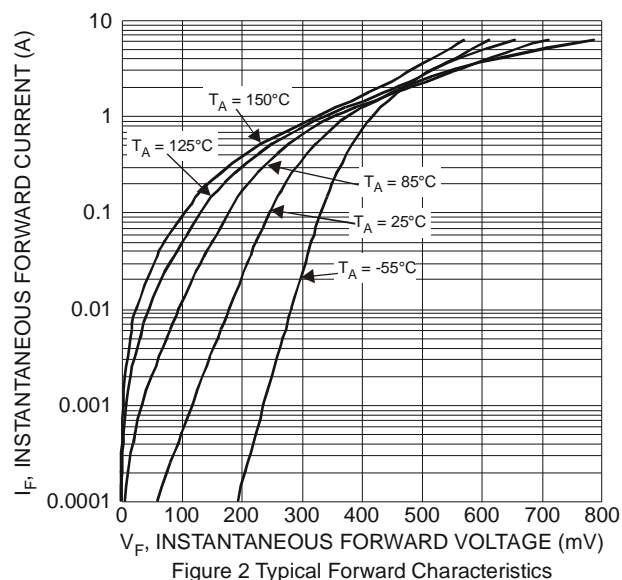
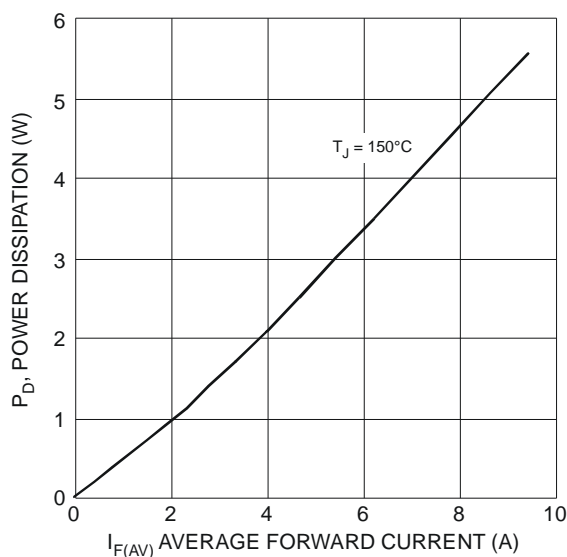
Thermal Characteristics (Per Leg)

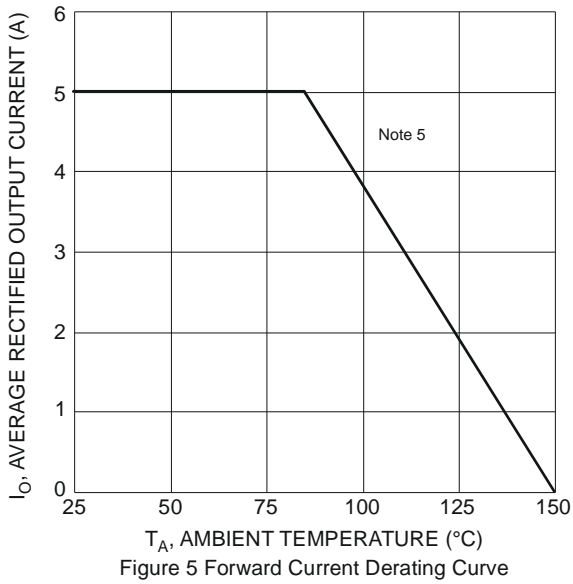
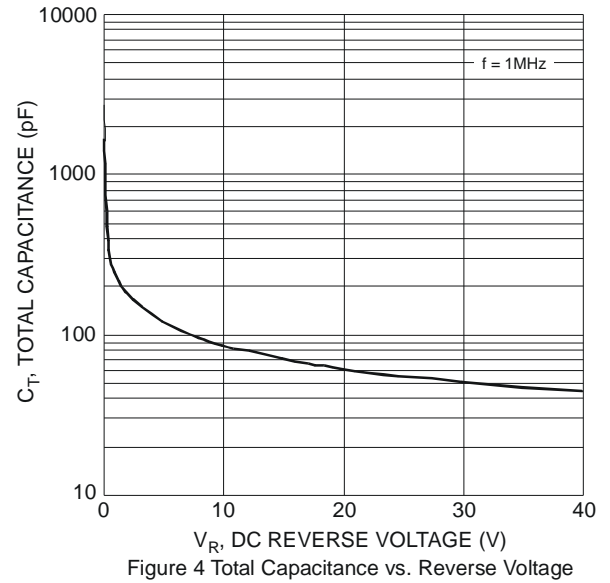
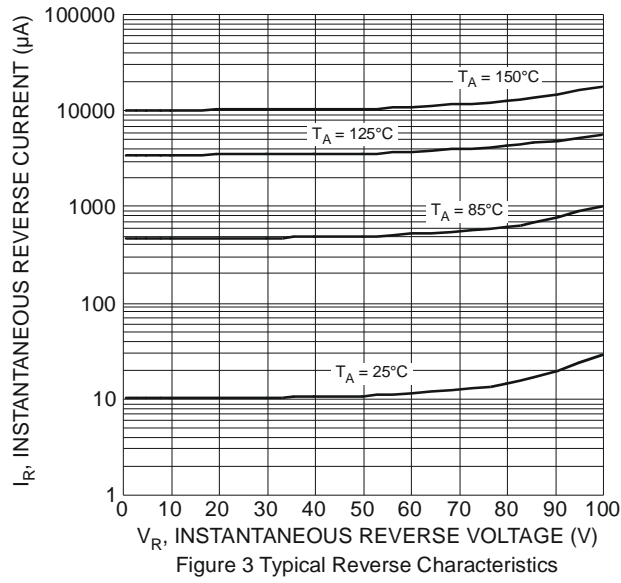
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	4	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	23	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (Per Leg) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)	V_F	—	0.56	0.64	V	$I_F = 3\text{A}, T_J = +25^\circ\text{C}$
			—	0.78		$I_F = 5\text{A}, T_J = +25^\circ\text{C}$
			—	0.63		$I_F = 3\text{A}, T_J = +125^\circ\text{C}$
Leakage Current (Note 6)	I_R	—	25	180	μA	$V_R = 100\text{V}, T_J = +25^\circ\text{C}$
			—	15	mA	$V_R = 100\text{V}, T_J = +125^\circ\text{C}$

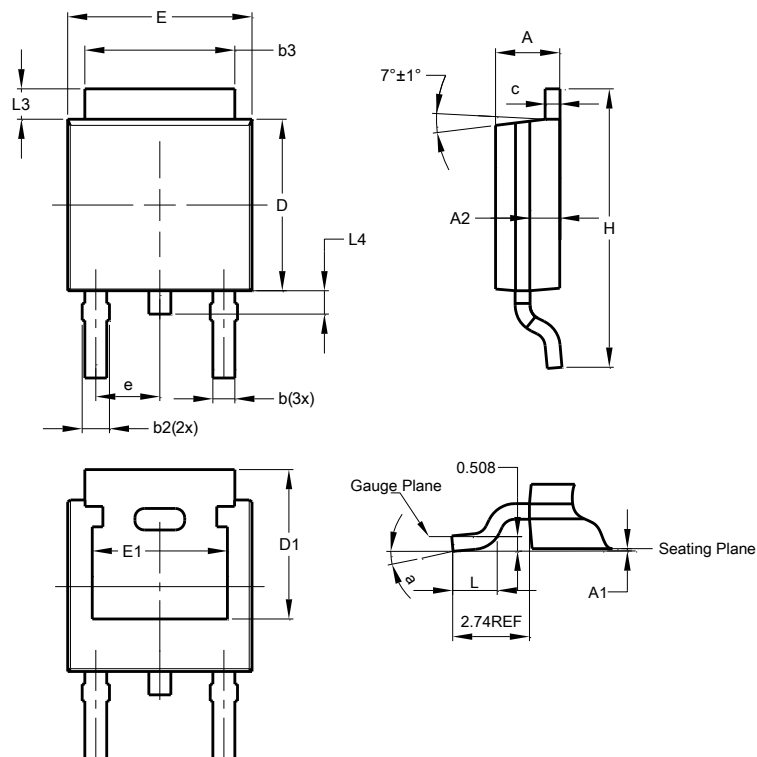
Notes: 5. Device mounted on Aluminum 2-inch sq. substrate board, 2oz.
 6. Short duration pulse test used to minimize self-heating effect.





Package Outline Dimensions

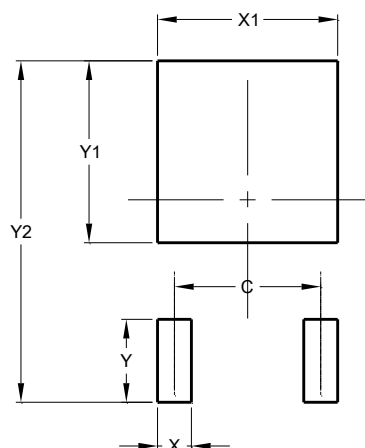
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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